Texas Instruments Inc. (DUNS# 00-732-1904) Supplier Name:

Contact Info:

ti.com/support
Distribute - RoHS and IEC 62474 DB Form/Declaration Type:

06/05/2022

Details for "OPA694IDR"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
OPA694IDR	NIPDAU	Level-2-260C-1 YEAR	TI MALAYSIA A/T	D 8	3.91x4.9x1.58	84.1

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire				•			
Other Nonferrous Metals and Alloys	Yttrium	7440-65-5	0.000001	0.000644	6	0.000001	C
Precious Metals	Gold	7440-57-5	0.155239	99.998068	999981	0.184572	1846
Precious Metals	Silver	7440-22-4	0.000002	0.001288	13	0.000002	(
Sub-Total			0.155242	100	1000000	0.184576	1846
Die Attach Adhesive							
Other Inorganic Materials	Silica	7631-86-9	0.003117	1.999718	19997	0.003706	37
Precious Metals	Silver	7440-22-4	0.107552	69.000205	690002	0.127875	1279
Thermoplastics	Ероху	85954-11-6	0.045203	29.000077	290001	0.053744	537
Sub-Total			0.155872	100	1000000	0.185325	1853
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	24.25509	97.41	974100	28.838252	288383
Copper and Its Alloys	Iron	7439-89-6	0.5976	2.4	24000	0.710521	710
Copper and Its Alloys	Phosphorus	7723-14-0	0.00747	0.03	300	0.008882	89
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.00747	0.03	300	0.008882	89
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.00747	0.03	300	0.008882	89
Zinc and Its Alloys	Zinc	7440-66-6	0.0249	0.1	1000	0.029605	296
Sub-Total			24.9	100	1000000	29.605022	296050
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.355273	95.119946	951199	0.422404	422
Precious Metals	Gold	7440-57-5	0.002913	0.77992	7799	0.003463	35
Precious Metals	Palladium	7440-05-3	0.015314	4.100134	41001	0.018208	182
Sub-Total			0.3735	100	1000000	0.444075	4441
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	49.890827	86.000001	860000	59.318034	593180
Other Plastics and Rubber	Carbon Black	1333-86-4	0.174038	0.3	3000	0.206924	2069
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	0.319069	0.55	5500	0.379359	3794
Thermoplastics	Epoxy	85954-11-6	7.628655	13.149999	131500	9.070141	9070:
Sub-Total			58.012589	100	1000000	68.974457	68974
Semiconductor Device	•			•			
Ceramics / Glass	Doped Silicon	7440-21-3	0.510148	100	1000000	0.606544	6065
Sub-Total			0.510148	100	1000000	0.606544	606
Total			84.107351			100	1000000

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component. See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology
For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Ti bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. Ti may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. Ti and Ti suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by Ti. The material content information is provided by TI "as is."

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/05/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

ROHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/odf/szzg088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.